

FEATURES

Computes:

- True rms value
- Average rectified value
- Absolute value

Provides:

- 200 mV full-scale input range
(larger inputs with input attenuator)
- Direct interfacing with 3 1/2 digit CMOS ADCs
- High input impedance: $10^{12} \Omega$
- Low input bias current: 25 pA max
- High accuracy: $\pm 0.2 \text{ mV} \pm 0.3\%$ of reading
- RMS conversion with signal crest factors up to 5
- Wide power supply range: $\pm 2.5 \text{ V}$ to $\pm 16.5 \text{ V}$
- Low power: 160 μA max supply current
- No external trims needed for specified accuracy
- AD736—a general-purpose, buffered voltage output version also available

GENERAL DESCRIPTION

The AD737¹ is a low power, precision, monolithic true rms-to-dc converter. It is laser trimmed to provide a maximum error of $\pm 0.2 \text{ mV} \pm 0.3\%$ of reading with sine wave inputs. Furthermore, it maintains high accuracy while measuring a wide range of input waveforms, including variable duty-cycle pulses and triac (phase) controlled sine waves. The low cost and small physical size of this converter make it suitable for upgrading the performance of non-rms precision rectifiers in many applications. Compared to these circuits, the AD737 offers higher accuracy at equal or lower cost.

The AD737 can compute the rms value of both ac and dc input voltages. It can also be operated ac-coupled by adding one external capacitor. In this mode, the AD737 can resolve input signal levels of 100 μV rms or less, despite variations in temperature or supply voltage. High accuracy is also maintained for input waveforms with crest factors of 1 to 3. In addition, crest factors as high as 5 can be measured (while introducing only 2.5% additional error) at the 200 mV full-scale input level.

The AD737 has no output buffer amplifier, thereby significantly reducing dc offset errors occurring at the output, which makes the device highly compatible with high input impedance ADCs.

¹ Protected under U.S. Patent Number 5,495,245.

Rev. F

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

FUNCTIONAL BLOCK DIAGRAM

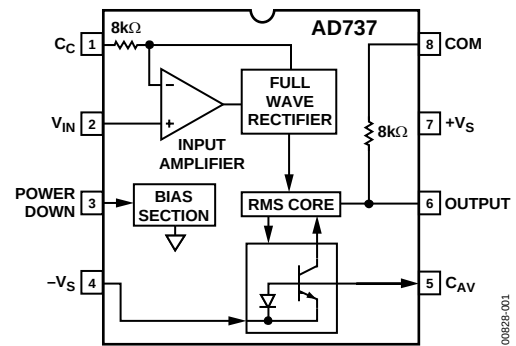


Figure 1.

Requiring only 160 μA of power supply current, the AD737 is optimized for use in portable multimeters and other battery-powered applications. This converter also provides a power-down feature that reduces the power-supply standby current to less than 30 μA .

Two signal input terminals are provided in the AD737. A high impedance ($10^{12} \Omega$) FET input interfaces directly with high R input attenuators, and a low impedance (8 k Ω) input accepts rms voltages to 0.9 V while operating from the minimum power supply voltage of $\pm 2.5 \text{ V}$. The two inputs can be used either single-ended or differentially.

The AD737 achieves 1% of reading error bandwidth, exceeding 10 kHz for input amplitudes from 20 mV rms to 200 mV rms while consuming only 0.72 mW.

The AD737 is available in four performance grades. The AD737J and AD737K grades are rated over the commercial temperature range of 0°C to 70°C . The AD737JR-5 is tested with supply voltages of $\pm 2.5 \text{ V}$ dc. The AD737A and AD737B grades are rated over the industrial temperature range of -40°C to $+85^\circ\text{C}$. The AD737 is available in three low cost, 8-lead packages: PDIP, SOIC, and CERDIP.

PRODUCT HIGHLIGHTS

1. The AD737 is capable of computing the average rectified value, absolute value, or true rms value of various input signals.
2. Only one external component, an averaging capacitor, is required for the AD737 to perform true rms measurement.
3. The low power consumption of 0.72 mW makes the AD737 suitable for battery-powered applications.

TABLE OF CONTENTS

Specifications.....	3	Rapid Settling Times via the Average Responding Connection	12
Absolute Maximum Ratings.....	5	DC Error, Output Ripple, and Averaging Error	13
ESD Caution.....	5	Ac Measurement Accuracy and Crest Factor	13
Pin Configurations and Function Descriptions	6	Selecting Practical Values for Capacitors	13
Typical Performance Characteristics	7	Application Circuits	15
Calculating Settling Time.....	10	Outline Dimensions	17
Types of AC Measurement	10	Ordering Guide	18
Theory of Operation	12		
RMS Measurement—Choosing Optimum Value For C_{AV}	12		

REVISION HISTORY

1/05—Rev. E to Rev. F

Updated Format.....	Universal
Added Functional Block Diagram.....	1
Changes to General Description Section	1
Changes to Pin Configurations and Function Descriptions Section	6
Changes to Typical Performance Characteristics Section.....	7
Changes to Table 4.....	11
Change to Figure 24	12
Change to Figure 27	15
Changes to Ordering Guide	18

6/03—Rev. D to Rev. E

Added AD737JR-5	Universal
Changes to FEATURES	1
Changes to GENERAL DESCRIPTION	1
Changes to SPECIFICATIONS.....	2
Changes to ABSOLUTE MAXIMUM RATINGS	4
Changes to ORDERING GUIDE	4
Added TPCs 16 through 19.....	6
Changes to Figures 1 and 2.....	8
Changes to Figure 8.....	11
Updated OUTLINE DIMENSIONS	12

12/02—Rev. C to Rev. D

Changes to FUNCTIONAL BLOCK DIAGRAM	1
Changes to PIN CONFIGURATION	4
Figure 1 replaced	8
Changes to Figure 2.....	8
Figure 5 replaced	10
Changes to Application Circuits Figures 4, 6–8	10
OUTLINE DIMENSIONS updated	12

12/99—Rev. B to Rev. C

SPECIFICATIONS

T = 25°C, ±5 V supplies, except AD737J-5, ±2.5 V, C_{AV} = 33 μF, C_C = 10 μF, f = 1 kHz, sine wave input applied to Pin 2, unless otherwise specified. Specifications shown in **boldface** are tested on all production units at final electrical test. Results from these tests are used to calculate outgoing quality levels.

Table 1.

Parameter	Conditions	AD737J/AD737A			AD737K/AD737B			AD737J-5			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
TRANSFER FUNCTION											
$V_{OUT} = \sqrt{Avg(V_{IN}^2)}$											
CONVERSION ACCURACY											
Total Error	E _{IN} = 0 to 200 mV rms ±V _S = ±2.5 V ±V _S = ±2.5 V, Input to Pin 1 E _{IN} = 200 mV – 1 V rms		0.2/0.3	0.4/0.5		0.2/0.2	0.2/0.3		0.2/0.3	0.4/0.5	±mV/±POR ¹ POR POR
T _{MIN} to T _{MAX}			–1.2	±2.0		–1.2	±2.0				POR
A and B Grades	E _{IN} = 200 mV rms			0.5/0.7			0.3/0.5				±mV/POR
J and K Grades	E _{IN} = 200 mV rms, ±V _S = ±2.5 V		0.007			0.007			0.02		±POR/°C
vs. Supply Voltage	E _{IN} = 200 mV rms										
±V _S = ±2.5 V to ±5 V		0	–0.18	–0.3	0	–0.18	–0.3	0	–0.18	–0.3	%/V
±V _S = ±5 V to ±16.5 V		0	0.06	0.1	0	0.06	0.1	0	0.06	0.1	%/V
DC Reversal Error, DC-Coupled	V _{IN} = 600 mV dc		1.3	2.5		1.3	2.5				POR
	V _{IN} = 200 mV dc, ±V _S = ±2.5 V								1.7	2.5	POR
Nonlinearity ²	E _{IN} = 0 to 200 mV rms E _{IN} = 100 mV rms	0	0.25	0.35	0	0.25	0.35				POR POR
Input to Pin 1, AC-Coupled ³	E _{IN} = 100 mV rms, after correction, ±V _S = ±2.5 V								0.02	0.1	
Total Error, External Trim	E _{IN} = 0 to 200 mV rms		0.1/0.2			0.1/0.2			0.1/0.2		±mV/±POR
ADDITIONAL CREST FACTOR ERROR ⁴											
Crest Factor = 1 to 3	C _{AV} = C _F = 100 μF C _{AV} = 22 μF, C _F = 100 μF, ±V _S = ±2.5 V, input to Pin 1		0.7			0.7			1.7		% %
Crest Factor = 5	C _{AV} = C _F = 100 μF		2.5			2.5					%
INPUT CHARACTERISTICS											
High Z Input (Pin 2)											
Signal Range											
Continuous RMS Level	±V _S = +2.5 V									200	mV rms
	±V _S = +2.8 V, –3.2 V			200			200				mV rms
	±V _S = ±5 V to ±16.5 V			1			1				V rms
Peak Transient Input	±V _S = +2.5 V, input to Pin 1							±0.6			V
	±V _S = +2.8 V, –3.2 V	±0.9			±0.9						V
	±V _S = ±5 V		±2.7			±2.7					V
	±V _S = ±16.5 V	±4.0			±4.0						V
Input Resistance			10 ¹²			10 ¹²			10 ¹²		Ω
Input Bias Current	±V _S = ±5 V		1	25		1	25		1	25	pA
Low Z Input (Pin 1)											
Signal Range											
Continuous RMS Level	±V _S = +2.5 V									300	mV rms
	±V _S = +2.8 V, –3.2 V			300			300				mV rms
	±V _S = ±5 V to ±16.5 V			1			1				V rms

AD737

Parameter	Conditions	AD737J/AD737A			AD737K/AD737B			AD737J-5			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Peak Transient Input	$\pm V_S = +2.5\text{ V}$ $\pm V_S = +2.8\text{ V}, -3.2\text{ V}$ $\pm V_S = \pm 5\text{ V}$ $\pm V_S = \pm 16.5\text{ V}$		± 1.7 ± 3.8 ± 11			± 1.7 ± 3.8 ± 11		± 1.7			V V V V
Input Resistance		6.4	8	9.6	6.4	8	9.6	6.4	8	9.6	k Ω
Maximum Continuous Nondestructive Input, All Supply Voltages				± 12			± 12			± 12	V p-p
Input Offset Voltage ⁵ vs. Temperature	AC-coupled		8	± 30		8	± 30		8	± 30	mV/ $^{\circ}\text{C}$
vs. Supply	$V_S = \pm 2.5\text{ V to } \pm 5\text{ V}$ $V_S = \pm 5\text{ V to } \pm 16.5\text{ V}$		80 50			80 50			80		$\mu\text{V/V}$ $\mu\text{V/V}$
OUTPUT CHARACTERISTICS—NO LOAD											
Output Voltage Swing	$\pm V_S = +2.8\text{ V}, -3.2\text{ V}$ $\pm V_S = \pm 5\text{ V}$ $\pm V_S = \pm 16.5\text{ V}$ $\pm V_S = \pm 2.5\text{ V (Pin 1)}$	-1.6 -3.3 -4	-1.7 -3.4 -5		-1.6 -3.3 -4	-1.7 -3.4 -5					V V V V
Output Resistance	dc	6.4	8	9.6	6.4	8	9.6	-1.1 6.4	-0.9 8		k Ω
FREQUENCY RESPONSE											
High Impedance Input (Pin 2)											
1% Additional Error	$V_{IN} = 1\text{ mV rms}$ $V_{IN} = 10\text{ mV rms}$ $V_{IN} = 100\text{ mV rms}$ $V_{IN} = 200\text{ mV rms}$		1 6 37 33			1 6 37 33			1 6 37 33		kHz kHz kHz kHz
3 dB Bandwidth	$V_{IN} = 1\text{ mV rms}$ $V_{IN} = 10\text{ mV rms}$ $V_{IN} = 100\text{ mV rms}$ $V_{IN} = 200\text{ mV rms}$		5 55 170 190			5 55 170 190			5 55 170 190		kHz kHz kHz kHz
Low Z Input (Pin 1)											
1% Additional Error	$V_{IN} = 1\text{ mV rms}$ $V_{IN} = 10\text{ mV rms}$ $V_{IN} = 40\text{ mV rms}$ $V_{IN} = 100\text{ mV rms}$ $V_{IN} = 200\text{ mV rms}$		1 6 90 90			1 6 90 90			1 6 25 90 90		kHz kHz kHz kHz kHz
3 dB Bandwidth	$V_{IN} = 1\text{ mV rms}$ $V_{IN} = 10\text{ mV rms}$ $V_{IN} = 100\text{ mV rms}$ $V_{IN} = 200\text{ mV rms}$		5 55 350 460			5 55 350 460			5 55 350 460		kHz kHz kHz kHz
POWER-DOWN											
Disable Voltage			0			0					V
Input Current, PD Enabled	$V_{PD} = V_S$		11			11					μA
POWER SUPPLY											
Operating Voltage Range		$+2.8/-3.2$	± 5	± 16.5	$+2.8/-3.2$	± 5	± 16.5	± 2.5	± 5	± 16.5	V
Current	No input Rated iInput Power-down		120 170 25	160 210 40		120 170 25	160 210 40		120 170 25	160 210 40	μA μA μA
TEMPERATURE RANGE					See the Ordering Guide						

¹ POR = % of reading.

² Nonlinearity is defined as the maximum deviation (in percent error) from a straight line connecting the readings at 0 V and 200 mV rms.

³ After fourth-order error correction using the equation $y = -0.31009x^4 - 0.21692x^3 - 0.06939x^2 + 0.99756x + 11.1 \times 10^{-6}$, where y is the corrected result and x is the device output between 0.01 V and 0.3 V.

⁴ Crest factor error is specified as the additional error resulting from the specific crest factor, using a 200 mV rms signal as a reference. The crest factor is defined as V_{PEAK}/V_{RMS} .

⁵ DC offset does not limit ac resolution.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage	± 16.5 V
Internal Power Dissipation ¹	200 mW
Input Voltage	$\pm V_S$
Output Short-Circuit Duration	Indefinite
Differential Input Voltage	$+V_S$ and $-V_S$
Storage Temperature Range (Q)	-65°C to $+150^{\circ}\text{C}$
Storage Temperature Range (N, R)	-65°C to $+125^{\circ}\text{C}$
Lead Temperature Range (Soldering 60 sec)	300°C
ESD Rating	500 V

¹ 8-Lead PDIP package: $\theta_{JA} = 165^{\circ}\text{C}/\text{W}$.

8-Lead CERDIP package: $\theta_{JA} = 110^{\circ}\text{C}/\text{W}$.

8-Lead SOIC: $\theta_{JA} = 155^{\circ}\text{C}/\text{W}$.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



AD737

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

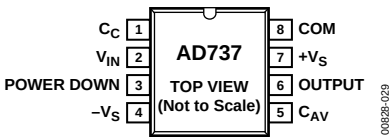


Figure 2. R-8 (SOIC) Pin Configuration

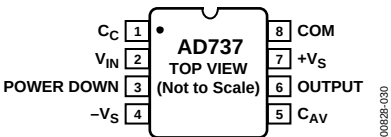


Figure 3. Q-8 (CERDIP) Pin Configuration

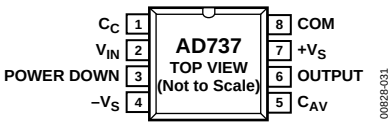


Figure 4. N-8 (PDIP) Pin Configuration

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	C _C	Coupling Capacitor for Indirect DC Coupling.
2	V _{IN}	RMS Input.
3	POWER DOWN	Disables the AD737. Low is enabled; high is powered-down.
4	−V _S	Negative Power Supply.
5	C _{AV}	Averaging Capacitor.
6	OUTPUT	Output.
7	+V _S	Positive Power Supply.
8	COM	Common.

TYPICAL PERFORMANCE CHARACTERISTICS

$T = 25^{\circ}\text{C}$, $\pm 5\text{ V}$ supplies, except AD737J-5, $\pm 2.5\text{ V}$, $C_{AV} = 33\text{ }\mu\text{F}$, $C_C = 10\text{ }\mu\text{F}$, $f = 1\text{ kHz}$, sine wave input applied to Pin 2, unless otherwise specified.

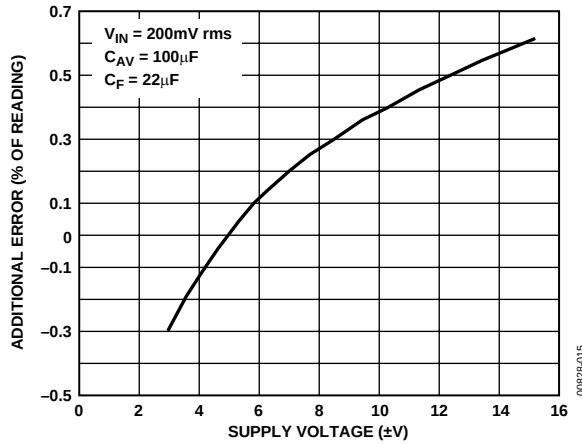


Figure 5. Additional Error vs. Supply Voltage

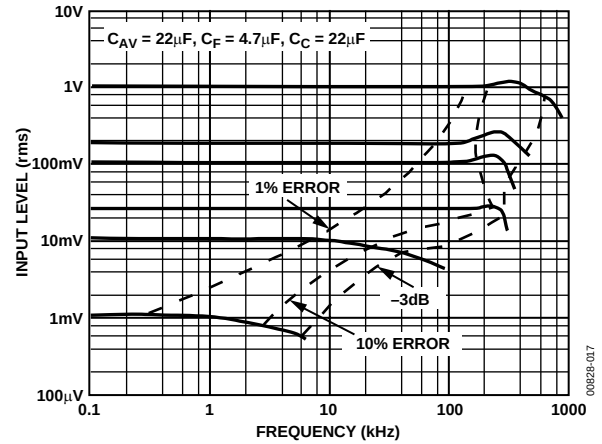


Figure 8. Frequency Response Driving Pin 1

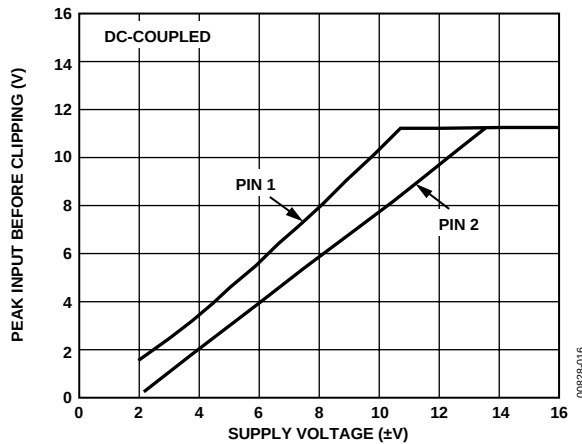


Figure 6. Maximum Input Level vs. Supply Voltage

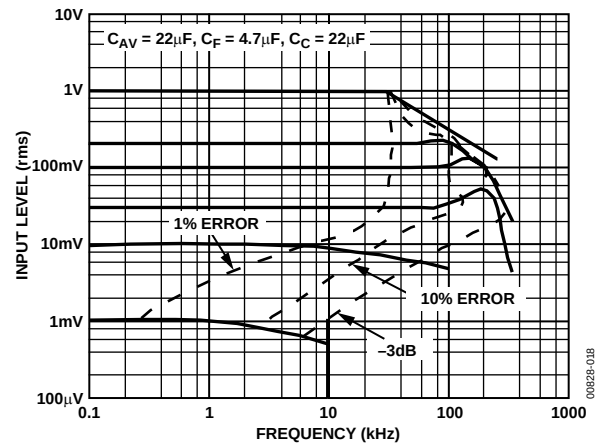


Figure 9. Frequency Response Driving Pin 2

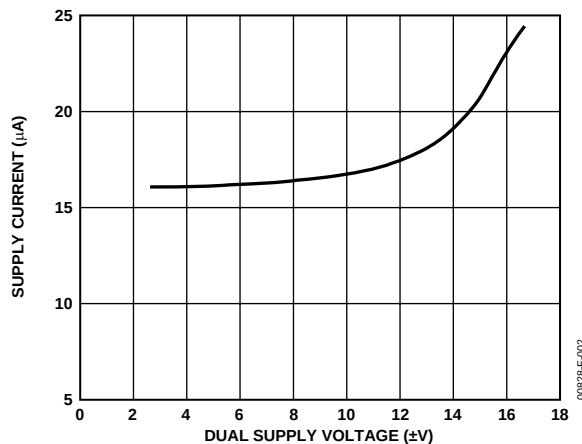


Figure 7. Power-Down Current vs. Supply Voltage

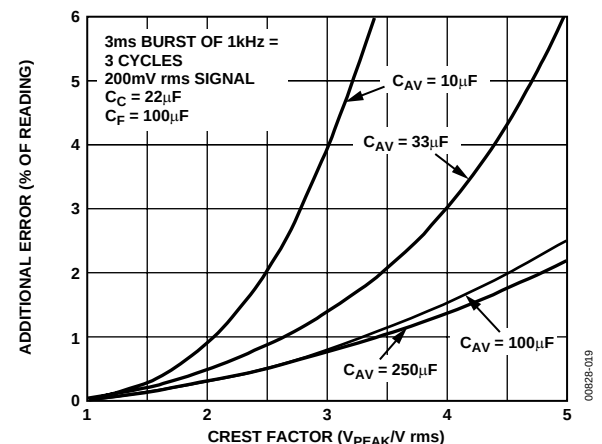


Figure 10. Additional Error vs. Crest Factor vs. C_{AV}

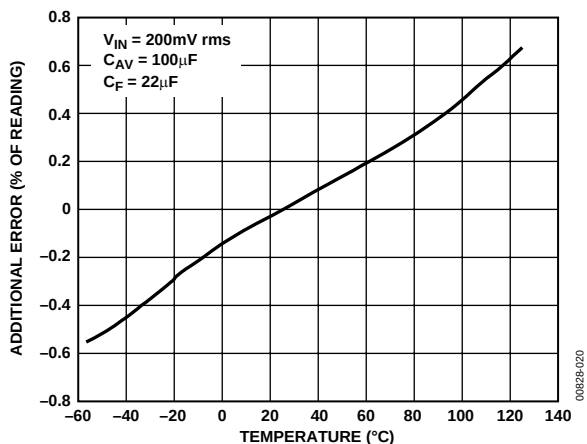


Figure 11. Additional Error vs. Temperature

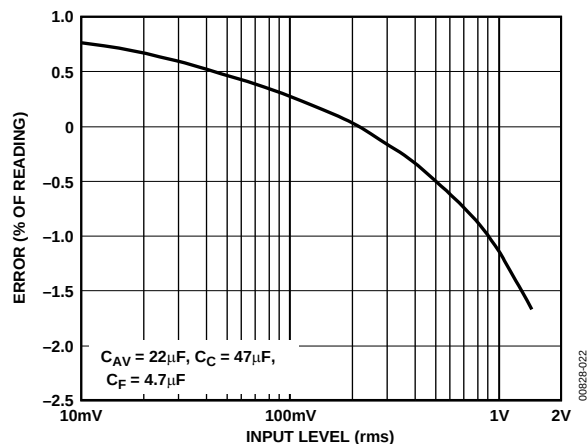


Figure 14. Error vs. RMS Input Voltage Using Circuit of Figure 29

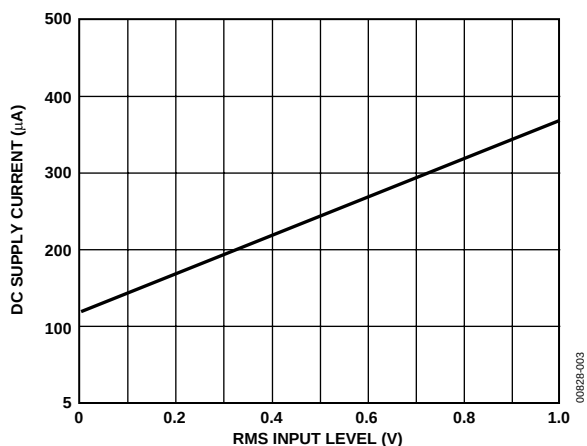


Figure 12. DC Supply Current vs. RMS Input Level

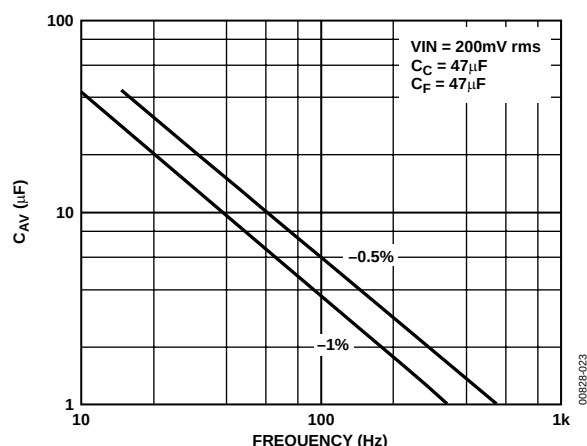


Figure 15. C_{AV} vs. Frequency for Specified Averaging Error

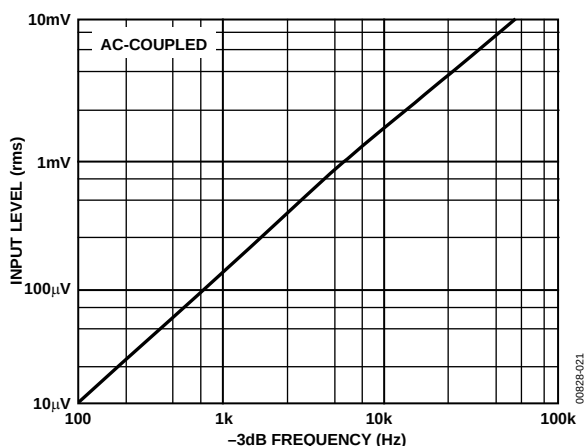


Figure 13. RMS Input Level vs. -3 dB Frequency

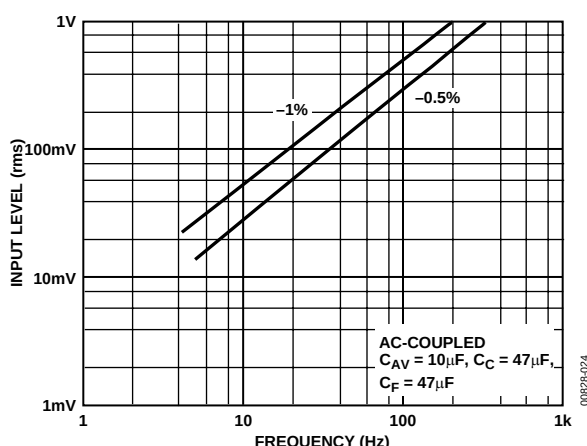


Figure 16. RMS Input Level vs. Frequency for Specified Averaging Error

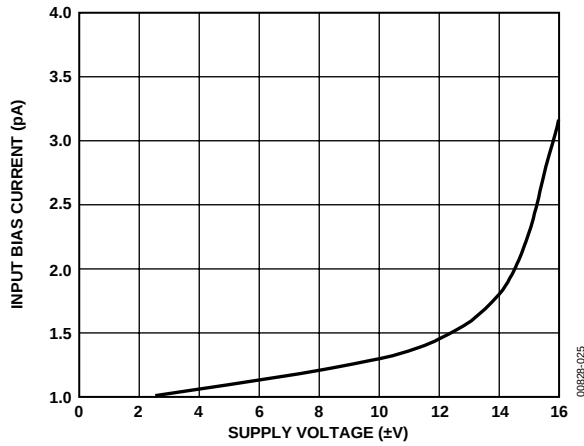


Figure 17. Input Bias Current vs. Supply Voltage

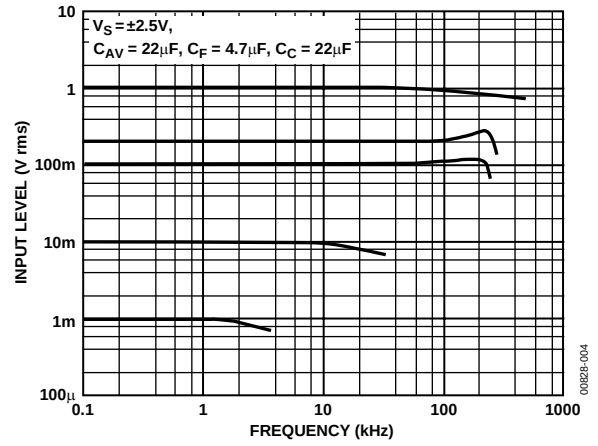


Figure 20. Frequency Response Driving Pin 1

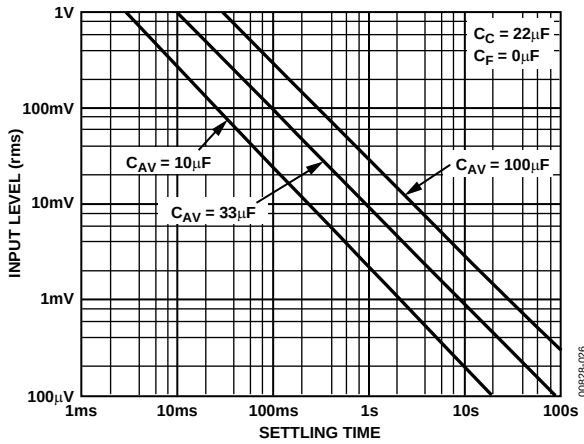


Figure 18. Settling Time vs. RMS Input Level for Various Values of C_{AV}

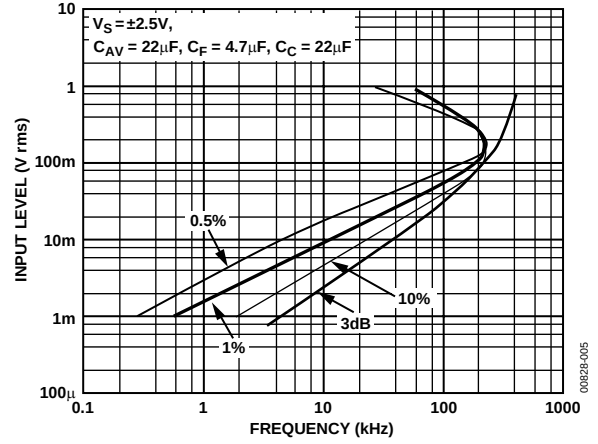


Figure 21. Error Contours Driving Pin 1

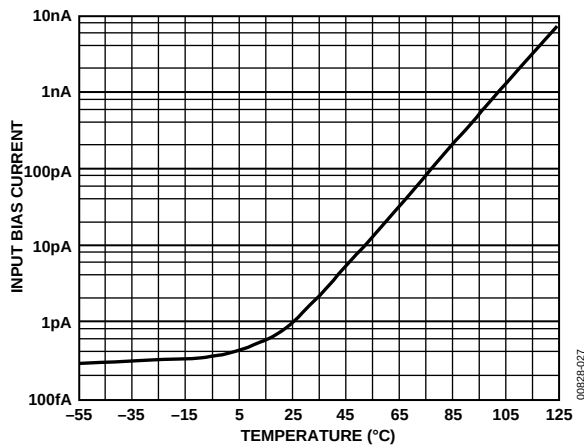


Figure 19. Input Bias Current vs. Temperature

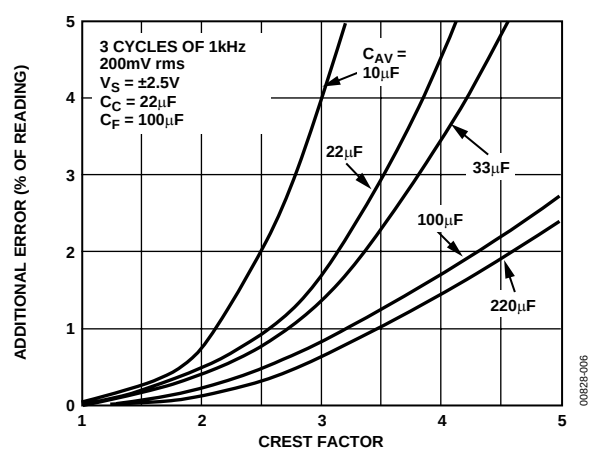


Figure 22. Additional Crest Factor Error for Various Values of C_{AV}

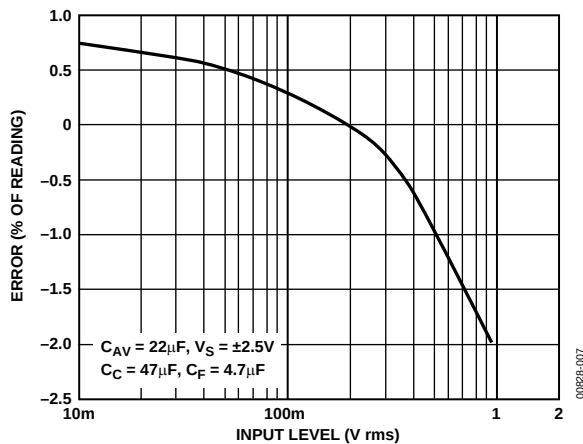


Figure 23. Error vs. Input Voltage Driving Pin 1

CALCULATING SETTling TIME

Figure 18 can be used to closely approximate the time required for the AD737 to settle when its input level is reduced in amplitude. The net time required for the rms converter to settle is the difference between two times extracted from the graph: the initial time minus the final settling time. As an example, consider the following conditions: a 33 μF averaging capacitor, an initial rms input level of 100 mV, and a final (reduced) input level of 1 mV. From Figure 18, the initial settling time (where the 100 mV line intersects the 33 μF line) is approximately 80 ms. The settling time corresponding to the new or final input level of 1 mV is approximately 8 seconds. Therefore, the net time for the circuit to settle to its new value is 8 seconds minus 80 ms, which is 7.92 seconds.

Note that because of the smooth decay characteristic inherent with a capacitor/diode combination, this is the total settling time to the final value (*not* the settling time to 1%, 0.1%, and so on, of the final value). Also, this graph provides the worst-case settling time, because the AD737 settles very quickly with increasing input levels.

TYPES OF AC MEASUREMENT

The AD737 is capable of measuring ac signals by operating as either an average responding or a true rms-to-dc converter. As its name implies, an average responding converter computes the average absolute value of an ac (or ac and dc) voltage or current by full wave rectifying and low-pass filtering the input signal; this approximates the average. The resulting output, a dc average level, is then scaled by adding (or reducing) gain; this scale factor converts the dc average reading to an rms equivalent value for the waveform being measured. For example, the average absolute value of a sine wave voltage is 0.636 that of V_{PEAK} ; the corresponding rms value is 0.707 times V_{PEAK} . Therefore, for sine wave voltages, the required scale factor is 1.11 (0.707 divided by 0.636).

In contrast to measuring the average value, true rms measurement is a universal language among waveforms, allowing the magnitudes of all types of voltage (or current) waveforms to be compared to one another and to dc. RMS is a direct measure of the power or heating value of an ac voltage compared to that of a dc voltage; an ac signal of 1 V rms produces the same amount of heat in a resistor as a 1 V dc signal.

Mathematically, the rms value of a voltage is defined (using a simplified equation) as

$$V_{\text{rms}} = \sqrt{\text{Avg}(V^2)}$$

This involves squaring the signal, taking the average, and then obtaining the square root. True rms converters are smart rectifiers; they provide an accurate rms reading regardless of the type of waveform being measured. However, average responding converters can exhibit very high errors when their input signals deviate from their precalibrated waveform; the magnitude of the error depends on the type of waveform being measured. As an example, if an average responding converter is calibrated to measure the rms value of sine wave voltages and then is used to measure either symmetrical square waves or dc voltages, the converter has a computational error 11% (of reading) higher than the true rms value (see Table 4).

Table 4. Error Introduced by an Average Responding Circuit When Measuring Common Waveforms

Type of Waveform 1 V Peak Amplitude	Crest Factor ($V_{\text{PEAK}}/V_{\text{rms}}$)	True RMS Value (V)	Reading of an Average Responding Circuit Calibrated to an RMS Sine Wave Value (V)	Error (%)
Undistorted Sine Wave	1.414	0.707	0.707	0
Symmetrical Square Wave	1.00	1.00	1.11	11.0
Undistorted Triangle Wave	1.73	0.577	0.555	-3.8
Gaussian Noise (98% of Peaks <1 V)	3	0.333	0.295	-11.4
Rectangular	2	0.5	0.278	-44
Pulse Train	10	0.1	0.011	-89
SCR Waveforms				
50% Duty Cycle	2	0.495	0.354	-28
25% Duty Cycle	4.7	0.212	0.150	-30

THEORY OF OPERATION

As shown in Figure 24, the AD737 has four functional subsections: input amplifier, full-wave rectifier, rms core, and bias section. The FET input amplifier allows both a high impedance, buffered input (Pin 2) or a low impedance, wide dynamic range input (Pin 1). The high impedance input, with its low input bias current, is well suited for use with high impedance input attenuators. The input signal can be either dc-coupled or ac-coupled to the input amplifier. Unlike other rms converters, the AD737 permits both direct and indirect ac coupling of the inputs. AC coupling is provided by placing a series capacitor between the input signal and Pin 2 (or Pin 1) for direct coupling and between Pin 1 and ground (while driving Pin 2) for indirect coupling.

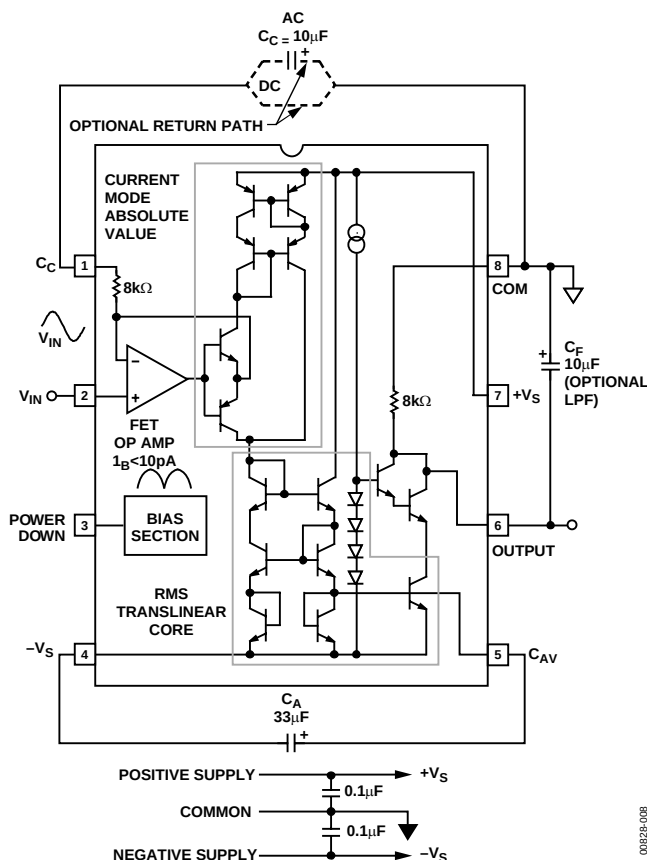


Figure 24. AD737 True RMS Circuit (Test Circuit)

The output of the input amplifier drives a full-wave precision rectifier, which, in turn, drives the rms core. It is in the core that the essential rms operations of squaring, averaging, and square rooting are performed, using an external averaging capacitor, C_{AV} . Without C_{AV} , the rectified input signal travels through the core unprocessed, as is done with the average responding connection (Figure 25).

In the average responding connection, all the averaging is carried out by an RC post filter consisting of an 8 kΩ internal scale-factor resistor connected between Pin 6 and Pin 8, and an external averaging capacitor, C_F . In the rms circuit, this additional filtering stage helps reduce any output ripple that was not removed by the averaging capacitor, C_{AV} .

A final subsection, the bias section, permits a power-down function. This reduces the idle current of the AD737 from 160 µA down to a mere 30 µA. This feature is selected by tying Pin 3 to the $+V_S$ terminal.

RMS MEASUREMENT—CHOOSING OPTIMUM VALUE FOR C_{AV}

Because the external averaging capacitor, C_{AV} , holds the rectified input signal during rms computation, its value directly affects the accuracy of the rms measurement, especially at low frequencies. Furthermore, because the averaging capacitor appears across a diode in the rms core, the averaging time constant increases exponentially as the input signal is reduced. This means that as the input level decreases, errors due to nonideal averaging decrease while the time it takes for the circuit to settle to the new rms level increases. Therefore, lower input levels allow the circuit to perform better (due to increased averaging) but increase the waiting time between measurements. When selecting C_{AV} , a trade-off between computational accuracy and settling time is required.

RAPID SETTLING TIMES VIA THE AVERAGE RESPONDING CONNECTION

Because the average responding connection shown in Figure 25 does not use an averaging capacitor, its settling time does not vary with input signal level; it is determined solely by the RC time constant of C_F and the internal 8 kΩ output scaling resistor.

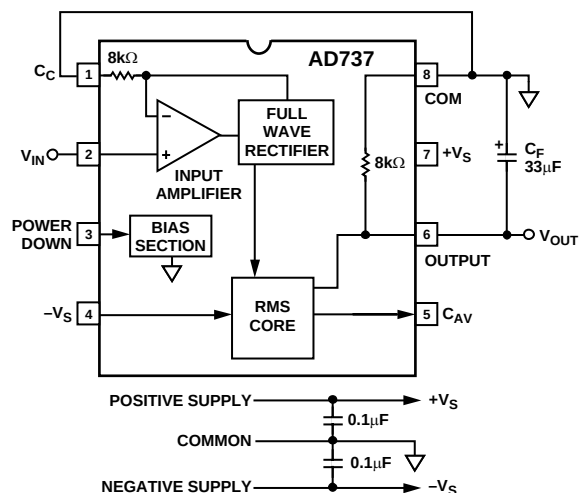


Figure 25. AD737 Average Responding Circuit

DC ERROR, OUTPUT RIPPLE, AND AVERAGING ERROR

Figure 26 shows the typical output waveform of the AD737 with a sine wave input voltage applied. As with all real-world devices, the ideal output of $V_{OUT} = V_{IN}$ is never exactly achieved; instead, the output contains both a dc and an ac error component.

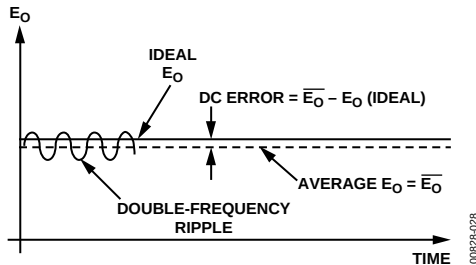


Figure 26. Output Waveform for Sine Wave Input Voltage

As shown, the dc error is the difference between the average of the output signal (when all the ripple in the output has been removed by external filtering) and the ideal dc output. The dc error component is, therefore, set solely by the value of the averaging capacitor used—no amount of post filtering (using a very large C_F) allows the output voltage to equal its ideal value. The ac error component, an output ripple, can be easily removed using a large enough postfiltering capacitor, C_F .

In most cases, the combined magnitudes of the dc and ac error components must be considered when selecting appropriate values for capacitors C_{AV} and C_F . This combined error, representing the maximum uncertainty of the measurement, is termed the averaging error and is equal to the peak value of the output ripple plus the dc error. As the input frequency increases, both error components decrease rapidly; if the input frequency doubles, the dc error and ripple reduce to one-quarter and one-half of their original values, respectively, and rapidly become insignificant.

AC MEASUREMENT ACCURACY AND CREST FACTOR

The crest factor of the input waveform is often overlooked when determining the accuracy of an ac measurement. Crest factor is defined as the ratio of the peak signal amplitude to the rms amplitude (Crest Factor = V_{PEAK}/V_{RMS}). Many common waveforms, such as sine and triangle waves, have relatively low crest factors (≥ 2). Other waveforms, such as low duty-cycle pulse trains and SCR waveforms, have high crest factors. These types of waveforms require a long averaging time constant to average out the long time periods between pulses. Figure 10 shows the additional error vs. the crest factor of the AD737 for various values of C_{AV} .

SELECTING PRACTICAL VALUES FOR CAPACITORS

Table 5 provides practical values of C_{AV} and C_F for several common applications.

The input coupling capacitor, C_C , in conjunction with the 8 k Ω internal input scaling resistor, determines the -3 dB low frequency roll-off. This frequency, F_L , is equal to

$$F_L = \frac{1}{2\pi (8,000) (\text{The Value of } C_C \text{ in Farads})}$$

Note that at F_L , the amplitude error is approximately -30% (-3 dB) of reading. To reduce this error to 0.5% of reading, choose a value of C_C that sets F_L at one-tenth of the lowest frequency to be measured.

In addition, if the input voltage has more than 100 mV of dc offset, then the ac coupling network at Pin 2 should be used in addition to capacitor C_C .

AD737

Table 5. AD737 Capacitor Selection

Application	RMS Input Level	Low Frequency Cutoff (–3 dB)	Maximum Crest Factor	C _{AV}	C _F	Settling Time ¹ to 1%
General-Purpose RMS Computation	0–1 V	20 Hz	5	150 µF	10 µF	360 ms
		200 Hz	5	15 µF	1 µF	36 ms
	0–200 mV	20 Hz	5	33 µF	10 µF	360 ms
		200 Hz	5	3.3 µF	1 µF	36 ms
General-Purpose Average Responding	0–1 V	20 Hz		None	33 µF	1.2 sec
		200 Hz		None	3.3 µF	120 ms
	0–200 mV	20 Hz		None	33 µF	1.2 sec
		200 Hz		None	3.3 µF	120 ms
SCR Waveform Measurement	0–200 mV	50 Hz	5	100 µF	33 µF	1.2 sec
		60 Hz	5	82 µF	27 µF	1.0 sec
	0–100 mV	50 Hz	5	50 µF	33 µF	1.2 sec
		60 Hz	5	47 µF	27 µF	1.0 sec
Audio Applications						
Speech	0–200 mV	300 Hz	3	1.5 µF	0.5 µF	18 ms
Music	0–100 mV	20 Hz	10	100 µF	68 µF	2.4 sec

¹ Settling time is specified over the stated rms input level with the input signal increasing from zero. Settling times are greater for decreasing amplitude input signals.

APPLICATION CIRCUITS

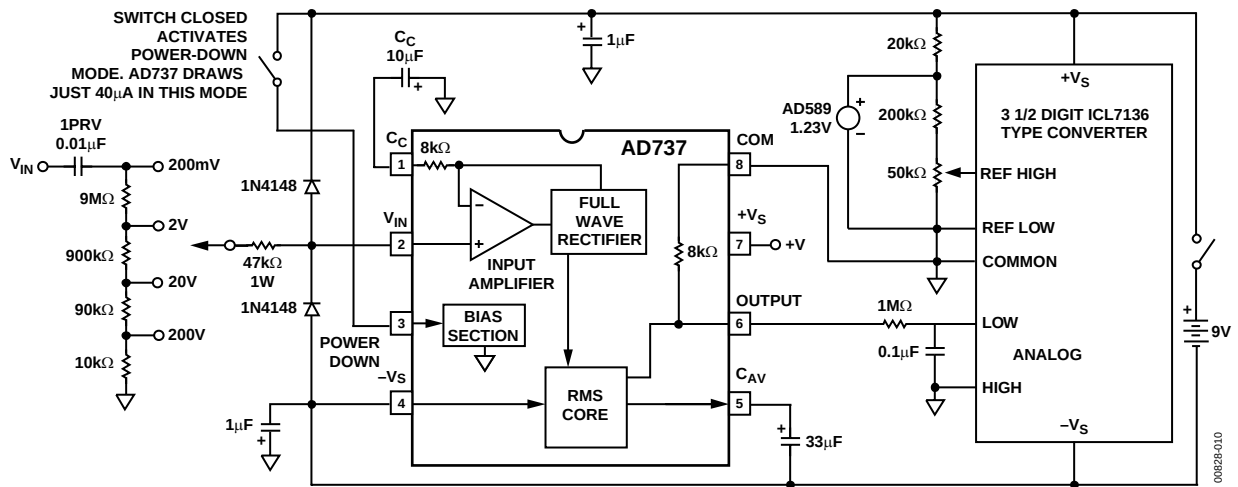


Figure 27. 3 1/2 Digit DVM Circuit

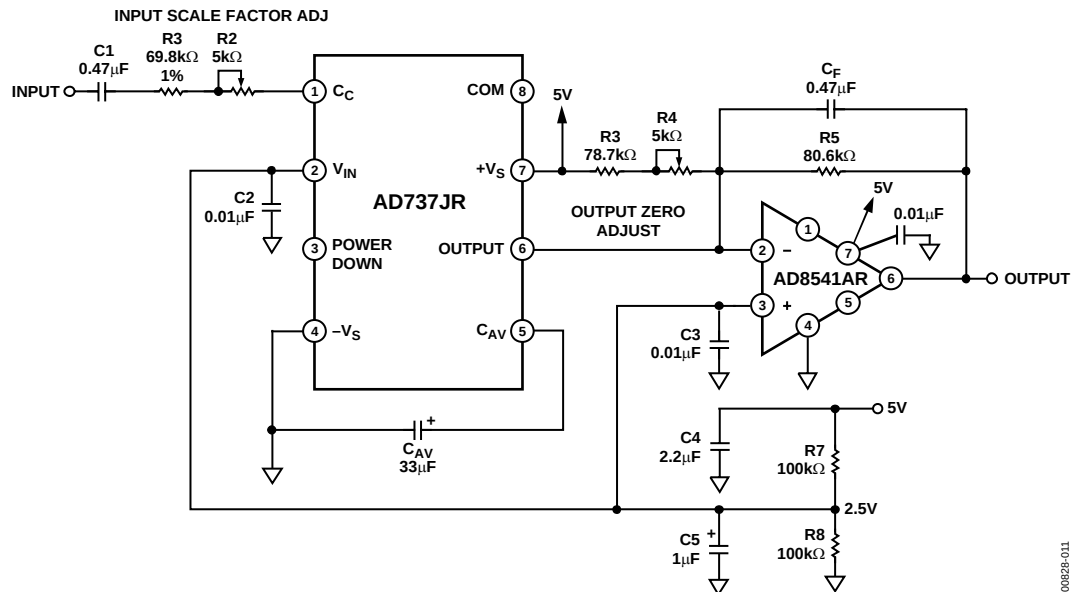


Figure 28. Battery-Powered Operation for 200 mV Maximum RMS Full-Scale Input

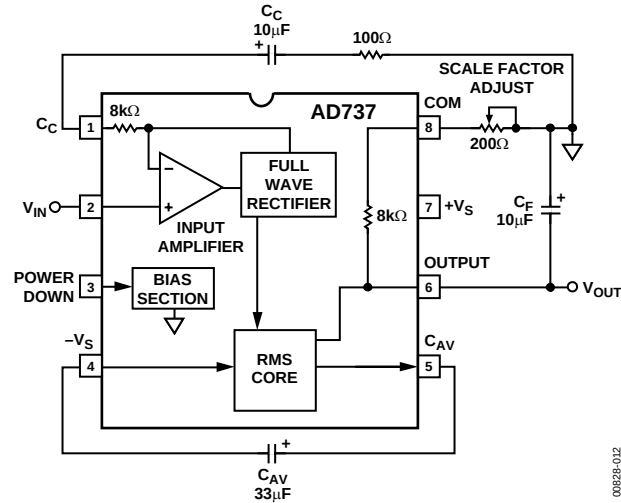


Figure 29. External Scale Factor Trim

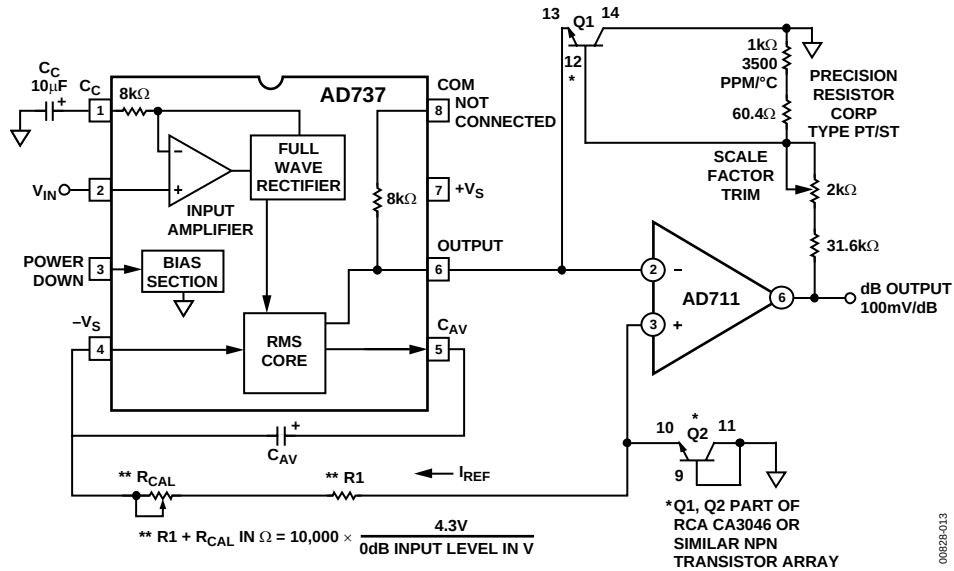


Figure 30. dB Output Connection

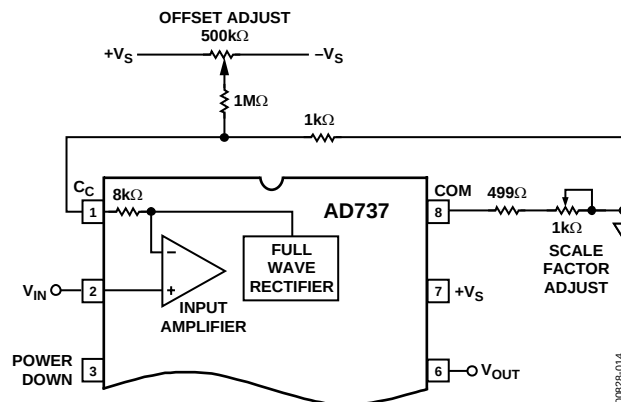
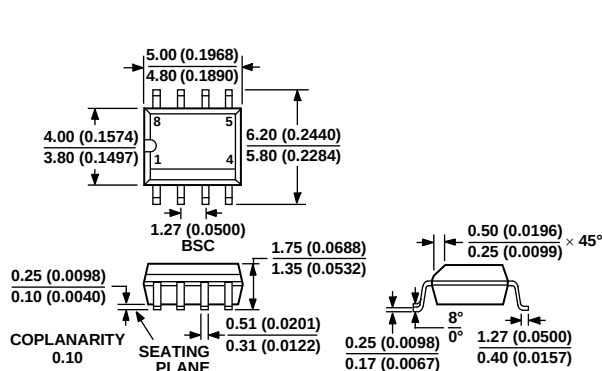


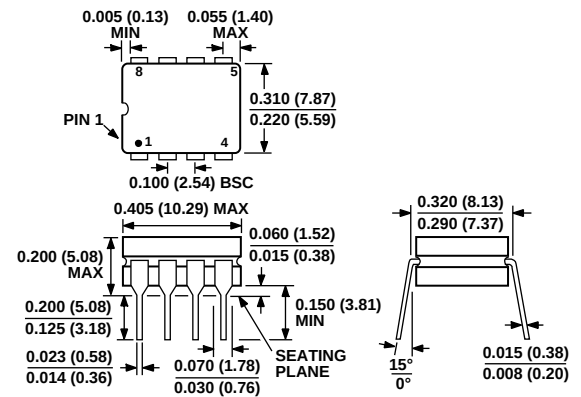
Figure 31. DC-Coupled V_{OS} and Scale Factor Trims

OUTLINE DIMENSIONS



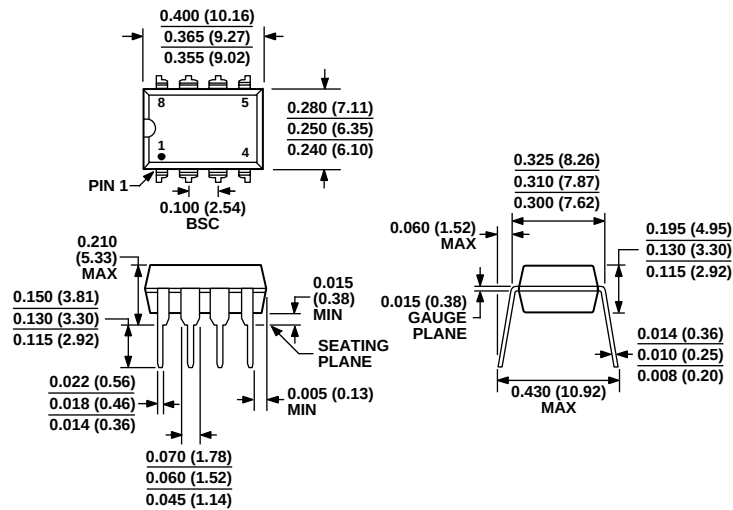
COMPLIANT TO JEDEC STANDARDS MS-012AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 32. 8-Lead Standard Small Outline Package [SOIC]
Narrow Body (R-8)
Dimensions shown in millimeters and (inches)



CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 33. 8-Lead Ceramic Dual In-Line Package [CERDIP]
(Q-8)
Dimensions shown in inches and (millimeters)



COMPLIANT TO JEDEC STANDARDS MS-001-BA
CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.
CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 34. 8-Lead Plastic Dual-In-Line Package [PDIP]
(N-8)
Dimensions shown in inches and (millimeters)

AD737

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
AD737AQ	–40°C to +85°C	8-Lead Ceramic Dual In-Line Package (CERDIP)	Q-8
AD737BQ	–40°C to +85°C	8-Lead Ceramic Dual In-Line Package (CERDIP)	Q-8
AD737JN	0°C to 70°C	8-Lead Plastic Dual-In-Line Package (PDIP)	N-8
AD737JNZ ¹	0°C to 70°C	8-Lead Plastic Dual-In-Line Package (PDIP)	N-8
AD737JR	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JR-5	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JR-5-REEL	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JR-5-REEL7	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JR-REEL	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JR-REEL7	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JRZ ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JRZ-5 ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JRZ-5-R7 ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JRZ-5-RL ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JRZ-R7 ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737JRZ-RL ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737KN	0°C to 70°C	8-Lead Plastic Dual-In-Line Package (PDIP)	N-8
AD737KNZ ¹	0°C to 70°C	8-Lead Plastic Dual-In-Line Package (PDIP)	N-8
AD737KR	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737KR-REEL	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737KR-REEL7	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737KRZ ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737KRZ-R7 ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8
AD737KRZ-RL ¹	0°C to 70°C	8-Lead Standard Small Outline Package (SOIC) Narrow Body	R-8

¹ Z = Pb-free part.

NOTES

AD737

NOTES